

### **Product Summary**

Device	V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub>	I <sub>D</sub> T <sub>A</sub> = 25°C
01	Q1 20V	$35m\Omega @ V_{GS} = 4.5V$	4.5A
QT		56m $\Omega$ @ V <sub>GS</sub> = 1.8V	3.5A
Q2	2 -20V -	74mΩ @ V <sub>GS</sub> = -4.5V	3.1A
QZ		2.0A	

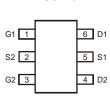
# **Description and Applications**

This MOSFET has been designed to minimize the on-state resistance (R<sub>DS(on)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Motor control
- **Power Management Functions**
- **DC-DC** Converters
- Backlighting



Top View



TSOT26

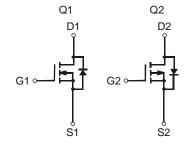
Top View

# **Features and Benefits**

- Low On-Resistance •
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Fast Switching Speed
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 standards for High Reliability

#### **Mechanical Data**

- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish --- NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.013 grams (approximate)



N-Channel P-Channel

Ordering Information (Note 3)

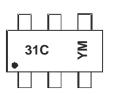
Part Number	Case	Packaging
DMC2038LVT-7	TSOT26	3000/Tape & Reel

1. No purposefully added lead. Notes:

2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.

3. For packaging details, go to our website at http://www.diodes.com.

# Marking Information



31C = Product Type Marking Code YM = Date Code Marking Y = Year (ex: X = 2010)M = Month (ex: 9 = September)

#### Date Code Key

Year	201	0	2011		2012	20	13	2014		2015	2	2016
Code	X	-	Y		Z	1	4	В		С		D
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# Maximum Ratings N-CHANNEL – Q1 @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Units			
Drain-Source Voltage			V <sub>DSS</sub>	20	V	
Gate-Source Voltage			V <sub>GSS</sub>	±12	V	
Continuous Drain Current (Note 4) $V_{GS}$ = 4.5V	Steady State	$T_A = 25^{\circ}C$ $T_A = 70^{\circ}C$	Ι <sub>D</sub>	4.5 3.6	А	
Continuous Drain Current (Note 4) $V_{GS}$ = 1.8V	Steady State	$T_A = 25^{\circ}C$ $T_A = 70^{\circ}C$	ID	3.5 2.8	А	
Continuous Drain Current (Note 5) $V_{GS}$ = 4.5V	Steady State	$T_A = 25^{\circ}C$ $T_A = 70^{\circ}C$	ID	3.7 3.0	А	
Continuous Drain Current (Note 5) $V_{GS}$ = 1.8V	Steady State	T <sub>A</sub> = 25°C T <sub>A</sub> = 70°C	ID	2.9 2.3	А	
Pulsed Drain Current (Note 6)		I <sub>DM</sub>	17	А		

### Maximum Ratings P-CHANNEL – Q2 @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic		Symbol	Value	Units	
Drain-Source Voltage		V <sub>DSS</sub>	-20	V	
Gate-Source Voltage			V <sub>GSS</sub>	±12	V
Continuous Drain Current (Note 4) $V_{GS}$ = 4.5V	Steady State	$T_A = 25^{\circ}C$ $T_A = 70^{\circ}C$	ID	3.1 2.5	А
Continuous Drain Current (Note 4) V <sub>GS</sub> = 1.8V		$T_A = 25^{\circ}C$ $T_A = 70^{\circ}C$	ID	2.0 1.6	А
Continuous Drain Current (Note 5) $V_{CS} = 4.5V$		$T_A = 25^{\circ}C$ $T_A = 70^{\circ}C$	lD	2.6 2.1	A
Continuous Drain Current (Note 5) $V_{CS} = 1.8V$		$T_A = 25^{\circ}C$ $T_A = 70^{\circ}C$	lD	1.7 1.3	A
Pulsed Drain Current (Note 6)	I <sub>DM</sub>	-12	А		

# Thermal Characteristics $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 4)	PD	1.13	W
Thermal Resistance, Junction to Ambient (Note 4)	$R_{ ext{ heta}JA}$	114	°C/W
Thermal Resistance, Junction to Case (Note 4)	$R_{ extsf{ heta}Jc}$	38.5	°C/W
Total Power Dissipation (Note 5)	PD	0.77	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ ext{ heta}JA}$	168	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

Notes: 4. Device mounted on FR-4 substrate PC board, 2oz copper, on 1inch square copper plate.

5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout

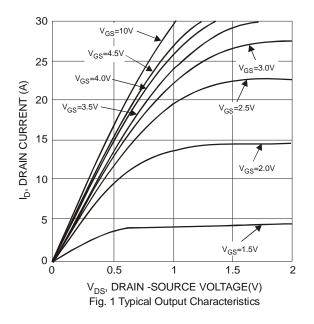
6. Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.

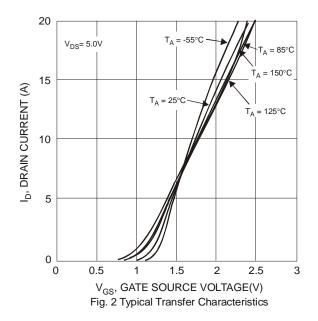


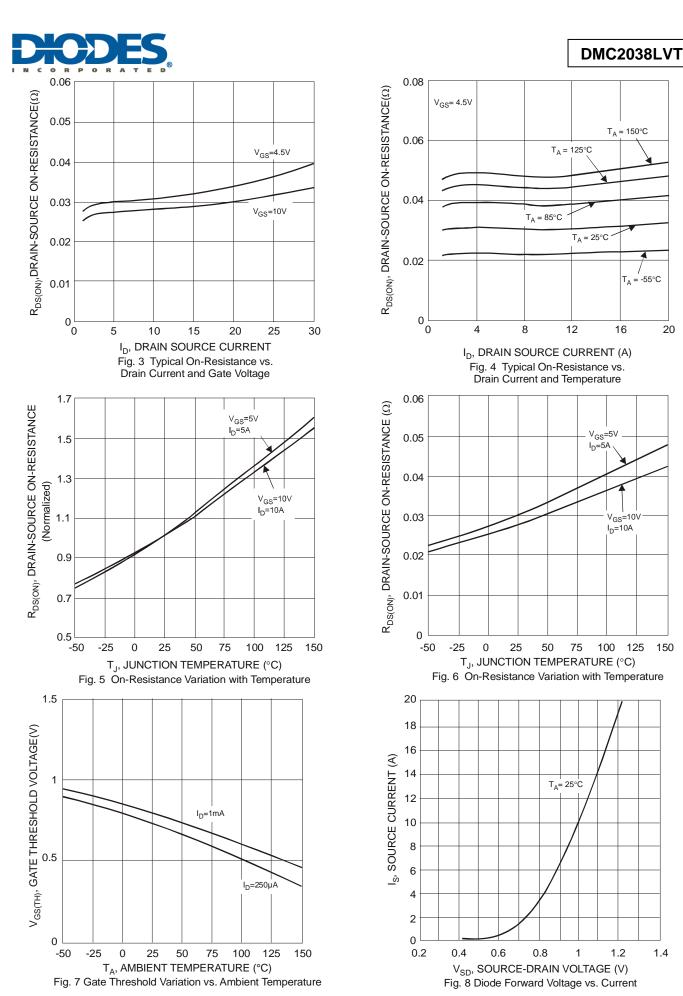
### Electrical Characteristics N-CHANNEL - Q1 @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	20	-	-	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	$@T_{c} = 25^{\circ}C$	I <sub>DSS</sub>	-	-	1.0	μA	$V_{DS} = 16V, V_{GS} = 0V$
Gate-Source Leakage		I <sub>GSS</sub>	-	-	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage		V <sub>GS(th)</sub>	0.4	-	1.0	V	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$
		R <sub>DS (ON)</sub>	-	27	35		$V_{GS} = 4.5V, I_D = 4.0A$
Static Drain-Source On-Resistance			-	33	43	mΩ	$V_{GS} = 2.5V, I_D = 2.5A$
			-	43	56		$V_{GS} = 1.8V, I_D = 1.5A$
Forward Transfer Admittance		Y <sub>fs</sub>	-	9	-	S	$V_{DS} = 5V, I_D = 3.4A$
Diode Forward Voltage		V <sub>SD</sub>	0.4	-	1.1	V	$V_{GS} = 0V, I_{S} = 1A$
Maximun Body-Diode Continuous Current		I <sub>S</sub>	-	-	4.5	А	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance		Ciss	-	400	530	pF	
Output Capacitance		Coss	-	70	90	pF	$V_{DS} = 10V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance		Crss	-	65	100	pF	1 = 1.00012
Gate Resistance		Rg	-	1.9	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge ( $V_{GS} = 4.5V$ )		Qg	-	5.7	-	nC	
Total Gate Charge (V <sub>GS</sub> = 10V)		Qg	-	12	17	nC	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 15V,
Gate-Source Charge		Qgs	-	0.7	-	nC	I <sub>D</sub> = 5.8A
Gate-Drain Charge		Q <sub>qd</sub>	-	1.4	-	nC	
Turn-On Delay Time		t <sub>D(on)</sub>	-	5	10	ns	
Turn-On Rise Time		tr	-	8	16	ns	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 4.5V,
Turn-Off Delay Time		t <sub>D(off)</sub>	-	25	40	ns	$R_{G} = 6\Omega, I_{DS} = 1A,$
Turn-Off Fall Time		tf	-	8	16	ns	7

 Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing. Notes:







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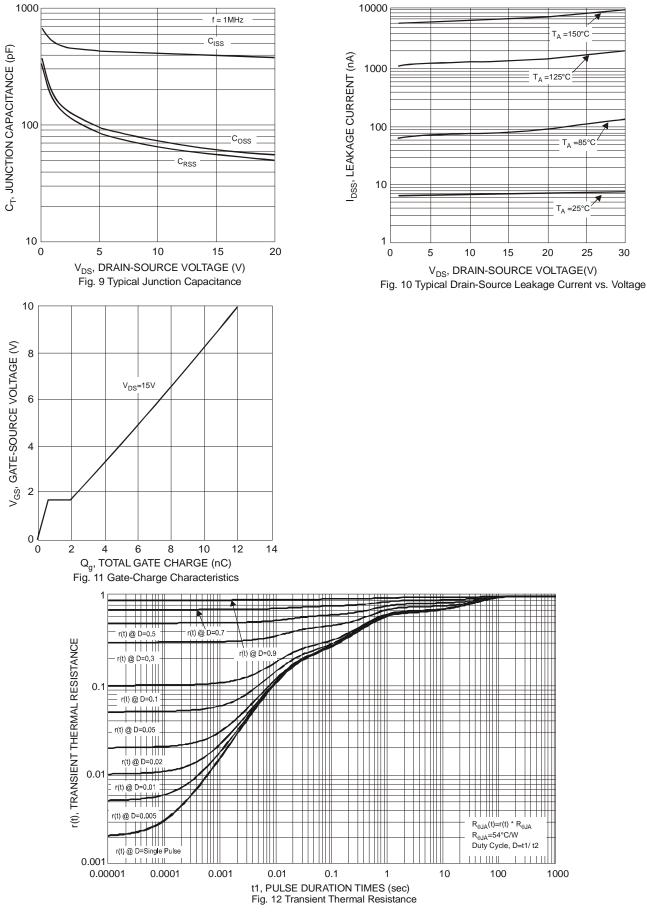
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# DMC2038LVT

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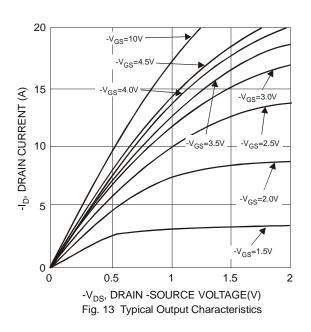


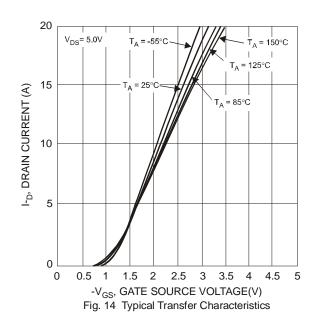


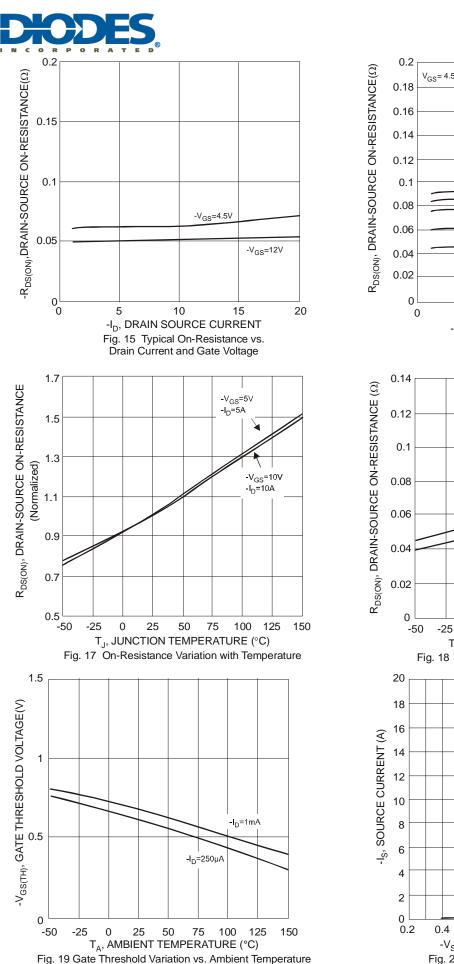
# Electrical Characteristics P-CHANNEL – Q2@TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	<b>BV</b> <sub>DSS</sub>	-20	-	-	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current @Tc = 25	5°C I <sub>DSS</sub>	-	-	-1.0	μA	$V_{DS} = -16V, V_{GS} = 0V$
Gate-Source Leakage	IGSS	-	-	±100	nA	$V_{GS} = \pm 12V$ , $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	-0.4	-	-1.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
		-	57	74		$V_{GS} = -4.5V, I_D = -3.0A$
Static Drain-Source On-Resistance	R <sub>DS (ON)</sub>	-	76	110	mΩ	V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -1.5A
		-	102	168		V <sub>GS</sub> = -1.8V, I <sub>D</sub> = -1.0A
Forward Transfer Admittance	Y <sub>fs</sub>	-	10	-	S	V <sub>DS</sub> = -5V, I <sub>D</sub> = -3.0A
Diode Forward Voltage (Note 6)	V <sub>SD</sub>	-	-0.8	-1.0	V	$V_{GS} = 0V, I_{S} = -0.6A$
Maximun Body-Diode Continuous Current	Is	-	-	-3.2	А	
DYNAMIC CHARACTERISTICS (Note 8)	·					
Input Capacitance	C <sub>iss</sub>	-	530	705	pF	
Output Capacitance	Coss	-	70	95	pF	$V_{DS} = -10V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	-	60	90	pF	1 = 1.0MHZ
Gate Resistance	Rq	-	72	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = -4.5V)	Qg	-	7	10	nC	
Total Gate Charge (V <sub>GS</sub> = -10V)	Qg	-	14	-	nC	V <sub>GS</sub> = -10V, V <sub>DS</sub> = -15V,
Gate-Source Charge	Q <sub>gs</sub>	-	0.95	-	nC	I <sub>D</sub> = -6A
Gate-Drain Charge	Q <sub>gd</sub>	-	1.2	-	nC	
Turn-On Delay Time	t <sub>D(on)</sub>	-	11	20	nS	
Turn-On Rise Time		-	12	22	nS	$V_{DS} = -10V, V_{GS} = -4.5V,$
Turn-Off Delay Time	t <sub>D(off)</sub>	-	21	34	nS	$R_{G} = 6\Omega, I_{S} = -1A,$
Turn-Off Fall Time	tf	-	13	23	nS	7

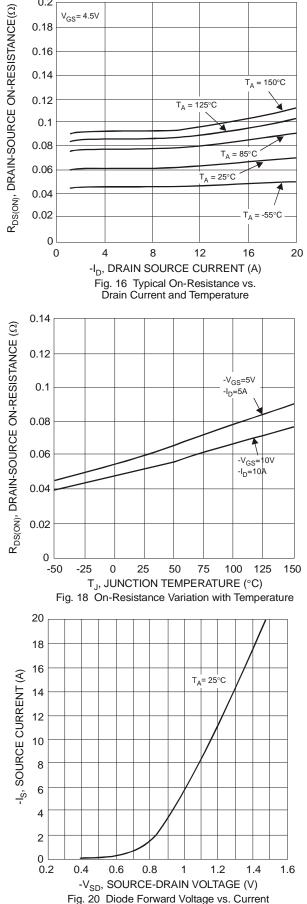
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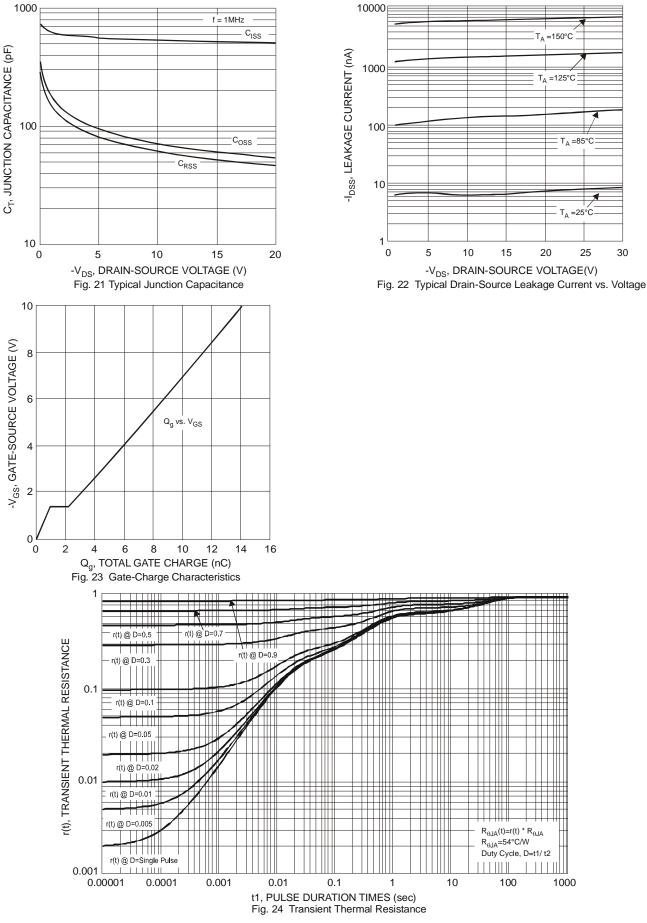


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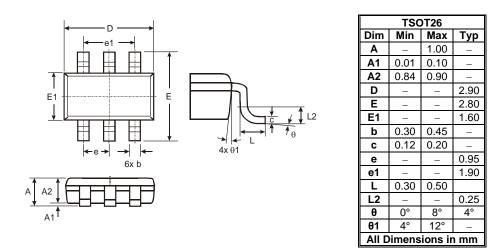
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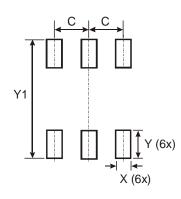
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# **Package Outline Dimensions**



# **Suggested Pad Layout**



Dimensions	Value (in mm)
С	0.950
X	0.700
Y	1.000
Y1	3.199



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